Energy dependent sputtering of nano-clusters from a nanodisperse target and embedding of nanoparticles into a substrate

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ABSTRACT

Au nanoparticles, prepared by them al evaporation under high vacuum condition on Si substrate, are irradiated with Au ions at di erent ion energies. During ion irradiation, embedding of nanoparticles as well as ejection of nano-clusters is observed. Ejected particles (usually smaller than those on the Si substrate) due to sputtering are collected on carbon-coated transm ission electron m icroscopy (TEM) grids. Both the TEM grids and the ion-irradiated samples are analyzed with TEM. Unirradiated as well as irradiated sam ples are also analyzed by Rutherford backscattering spectrom etry (RBS). In the case of low energy (32 keV) ions, where the nuclear energy loss is dom inant, both sputtering and embedding are less compared to medium energy (1.5 MeV). In the high energy regime (100 MeV), where the electronic energy loss is dom inant, sputtering is maximum but practically there is no embedding. Ion bombardment of surfaces at an angle with respect to the surface-norm alproduces enhanced em bedding com pared to norm al-incidence born bardment. The depth of embedding increases with larger angle of incidence. Au nanoparticles after ion irradiation form embedded gold-silicide. Size distribution of the sputtered Au clusters on the TEM grids for dierent ion energy regim es are presented.

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1 Introduction

Sputtering from solids interacting with energetic particles is an active research area of great fundamental and applied interest. Momentum transfer to target atoms can be accomplished through elastic collisions or electronic processes. Linear collision cascade theory [1] has been used most successfully in describing the sputtering of metals by ions of keV energies. Enhancements due to elastic collision spikes are observed when both projectile and target consist of very high Z materials [2].

When an energetic particle passes into a solid, collisions induce several processes occur such as recoil and sputtering of constituent atoms, defect form ation, electron excitation and emission, and photon emission. The sputtering process, especially emission process of secondary ions, has been widely studied for various target materials under bombardment of heavy ions. Most of studies are, however, concerned with secondary ion mass spectrometry (SIMS) at nuclear-collision dominant low energies [3-9]. In a MeV-energy range, an electronic-energy-loss process becomes dominant, [10] and the basic process of secondary ion emission is dierent from that in the low energy range because the electronic behavior strongly depends on the solid state property.

Birtcher et al. [11] reported ejection of nanoparticles from Au Imsthatwere irradiated with 50 - 400 keV Xe ions, providing evidence for pulsed plastic ow on the material structure. Rehn et al. [12] reported the size distributions of the large clusters (500 atom s) that are sputtered from the surface of thick Im s by high energy ion im pacts (400 and 500 keV: Ne, Ar, Kr, and Au). They proposed that the clusters are produced when shock waves, generated by subsurface displacem ent cascades, in pact and ablate the surface, as predicted in the model of Bitensky and Parilis [13]. Quite recently, a more representative set of data on sputtering of metal targets (Au and Ag Ims with thickness of 1000 nm) with cluster ions of Au_n (n = 1-5 [14], n = 1-13 [15]) with the energy from 20 keV/at. to 5 M eV/at. was obtained. Sputtering phenomenon can be expected to be considerably stronger in small nite system s like clusters [16, 17, 18]. The bom bardment of Au clusters deposited on native-oxide/Si (100) surfaces has been investigated experimentally with ion energy and impact angle. Baranov et al. [17] reported sputtering of nanodispersed targets by 6 M eV Au₅ cluster ions (12 M eV/at.) and found that the size distribution of desorbed clusters are system atically shifted towards smaller sizes by comparison with the grain size distributions on the targets. Theoretical studies by Shapiro and Tombrello [19] showed that both the ballistic and therm al spike phases of collision cascades contribute signi cantly to the non-linearity and the large sputtering yields observed in the bom bardment of gold targets with small gold clusters.

Ion beam mixing is a well-known technique for the form ation of metastable and/or equilibrium phases in thin lm structures [20-22]. The form ation of silicides caused by the penetration of energetic ions through the interface between a metal-lm and silicon has long back been recognized as one of the aspects of ion beam induced reactions in thin lm structures [20, 21]. Lau et al. [22] reported about the ion beam mixing of four metal-sem iconductor eutectic systems (Au-Si, Au-Ge, Al-Ge and Ag-Si). A coording to this report, for the Au-Si system, uniform lm mixed am orphous layer with composition of Au₇₁Si₂₉ was formed. These studies were on continuous thin lm s. For nanostructural islands (Au islands on Si) mixing can occur where ion range is much larger compared to the island thickness [23, 24].

M ost of the above mentioned works were done where target Ims were continuous and projectile was monomer or cluster ion. We have done the measurements on nanodispersed target with monomer ion and the catcher grid being placed very far from target (1 cm) at RT. This reduces the probability of agglomeration of nanoclusters coming out of the target and deposited on the catcher grid. We observe higher sputtering and higher probability of crater formation in nanodispersed gold target compare to thick semi-continuous and continuous target due to MeV self-ion irradiation and propose it as an experimental evidence of the energy spike connement elect [18, 25]. An energy spike within the nanoislands which can result either in a thermal spike or a shock wave could see a spatial connement elects in nanoislands. Kissel and Urbassek [16] studied theoretically the elect of 100 keV. Au atom bombardment on spherical Auclusters (radius of 4 nm.) using molecular-dynamics simulation and showed that this bombardment may result in total disintegration of the clusters.

2 Experim ental

In this study, we use single crystal n-type Si(100) substrates (with native oxide of $2\,\mathrm{nm}$). These substrates were cleaned sequentially in ultrasonic bath with acetone, methanol, trichloroethylene, methanol, deionized water and acetone. Au $\,\mathrm{lm}$ softhickness 1.3 and 2.6 nm were deposited at a rate of 0.1 nm/s by therm allevaporation under high-vacuum conditions ($\,\mathrm{2}\,\mathrm{10}^{\,6}\,\mathrm{m}$ bar) onto Si at room temperature (RT). Ion sputtering experiments were

perform ed mainly with $1.5 \,\mathrm{M}$ eV $\mathrm{Au^{2+}}$ ions with uence of 10^{14} ions cm 2 at di erent angles of incidence with respect to the surface normal. Supplem entary studies done with 32 keV Au ions, and 100 M eV Au⁸⁺ ions. The ion current for the irradiations was 30 nA for 32 keV and 1.5 M eV irradiation 15 nA for 100 M eV irradiation (under secondary electron suppressed geometry). To achieve uniform irradiation the ion beam was raster over an area of 1 1 cm². During irradiation, 2 10⁷ m bar pressure was maintained in the irradiation chamber and sputtered particles were collected on a carbon coated TEM grid (catcher grid) that was positioned 1 cm above the target and the catcher surface making an angle (15) with respect to the sample surface. Transm ission electron m icroscopy (TEM) m easurem ents were carried out with 200 keV electrons (JEOL JEM-2010). The cross-section and the planar sam ples were prepared using mechanical thinning followed by 3.0 keV Ar ion milling. The amount of deposited material (the e ective Im thickness) was measured by Rutherford backscattering spectrometry (RBS) using 2 M eV H e+ ions.

3 Results and Discussions

Gold initially grows as islands rather than uniform—In son the native-oxide-covered Sisubstrates. The amount of deposited material is expressed in terms of an elective thickness, which would be the actual—In thickness if the—In were deposited as a—In of uniform thickness. The elective thickness has been determined by using the bulk atomic density of Auwith RUMP simulation package [26]. The error on elective thickness determination was 10%. The maximum height of the Au island is 30 nm. The particle size and the surface coverage have been determined from the TEM micrographs with the help of ImageJ software [27]. The amount of gold lost from the sample due to sputtering during irradiation has been calculated from RBS measurements. Projected range for Au ions in Si and Au for dierent ion energies is shown in Table 1.

Au Ims of thickness 1.3 nm and 2.6 nm was used for the present study. Fig. 1(a) shows a plan-view TEM image for as-deposited 2.6 nm Au Ims on native-oxide/Si substrate with 44% surface coverage of islands. Figs. 1(b), (c) and (d) show the TEM images of the sputtered particles collected from samples like the one shown in Fig. 1(a), which were irradiated with 32 keV, 1.5 MeV and 100 MeV Au ions, respectively, at a uence of $1 \cdot 10^{14}$ ions cm 2 at normal incidence. From these gures, it is evident that in case of low energy (keV) ions, sputtering is less compare to high energy (MeV) in

Table 1: Projected range for Au ions in Si and Au for di erent ion energies (using the SR IM 2003 range calculation [28]).

Au ion energy	Projected range in Si	Projected range in Au
32 keV	23.4 nm	5.6 nm
1.5 M eV	360 nm	100 nm
100 M eV	14.7 m	5.2 m

this case (sputtering from nanoisland lms). Fig. 1 (e) shows a TEM image (from the same region as in Fig. 1 (d)) from the catcher grid obtained by some underfocousing of the objective lens. The form of the image of the Au particles shows the spherical nature of the sputtered particles. Fig. 1 (f) shows high resolution image of a sputtered particle obtained from Fig. 1 (d). High resolution image shows crystalline nature of sputtered particles. Sputtered particles obtained for irradiation with 32 keV and 1.5 MeV are also crystalline and spherical in nature (data not shown).

The size distribution of the sputtered particles collected on catcher grids are shown in Fig. 2. The histogram s shown in Figs. 2(a), (b) and (c) have been determ ined from many TEM in ages like Figs. 1(b), (c) and (d) respectively. Fig. 1(a) shows a bim odal size distribution for the sputtered particles with 2% surface coverage of islands for 32 keV ion irradiation. Fig. 1(b) shows monom odal size distribution for the sputtered particles with 14% surface coverage of islands for 1.5 M eV ion irradiation; here the mean size of islands is 7.5 0.1 nm and standard deviation in size distribution is 3.7 0.2 nm. Fig. 1(c) shows monom odal size distribution for the sputtered particles with 9% surface coverage of islands for 100 M eV ion irradiation; here the mean island size is 9.6 0.1 nm and standard deviation in size distribution is 4.6 0.2 nm. Though surface coverage of sputtered particles for 1.5 M eV ion irradiation is more (14%) than 100 M eV Au ion irradiation (9%) but average sputtered particle size is more for 100 M eV irradiation than 1.5 M eV irradiation.

Figs. 3(a), (b) and (c) show RBS spectra obtained from as-deposited 2.6 nm Au/Si and same samples irradiated with 32 keV, $1.5\,\mathrm{M}$ eV and $100\,\mathrm{M}$ eV Au ions respectively with uence of $1\,10^{14}$ ions cm 2 at normal incidence. Loss of Au from the sample due to sputtering can be estimated from these spectrum's. RBS measurements showing more sputtering in case of $100\,\mathrm{M}$ eV Au irradiation by reducing the total Au signal and less sputtering in case of $100\,\mathrm{M}$ eV Au irradiation compared to $1.5\,\mathrm{M}$ eV Au ion irradiation. From the

RBS analyses we observe: (a) in case of 32 keV irradiation, the elective Im thickness reduces from 2.6 nm to 1.5 nm upon ion irradiation (an elective reduction of 1.1 nm due to irradiation, i.e. an 42% thickness reduction (relative to the initial thickness), (b) in case of 1.5 MeV irradiation the elective Im thickness reduces from 2.6 nm to 0.3 nm (an elective reduction of 2.3 nm occurred due to irradiation, i.e. a 88% thickness reduces from 2.6 nm to 0 nm (an elective reduction of 2.6 nm occurred due to irradiation, i.e. a 100% thickness reduction). Obviously the sputtering yield is higher for 100 MeV ion irradiation. We have calculated relative sputtering yield (Y) for these ion energies from RBS measurements,

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Y (at 32 keV): Y (at 1.5 \text{ M eV}): Y (at 100 \text{ M eV}) = 1:2.1:2.4
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Figs. 4(a), (b) and (c) show XTEM images of 2.6 nm Au/native-oxide /Si, irradiated with uence of 1 10^{14} ions cm 2 at 0 -impact angle with 32 keV Au ions, $1.5\,\mathrm{M}$ eV Au $^{2+}$ ions and $100\,\mathrm{M}$ eV Au $^{8+}$ ions respectively. In case of 32 keV embedding is less compared to $1.5\,\mathrm{M}$ eV case. For $100\,\mathrm{M}$ eV, there is no embedding. We have seen very less sputtering in case of thick continuous lm compare to island thin lm [18].

Fig. 5 (a) show the XTEM images of $1.3 \, \mathrm{nm}$ Au/native-oxide/Si. Figs. 5 (b), (c) and (d) show the XTEM images of such samples shown in Fig. 5 (a) irradiated with $1.5 \, \mathrm{MeV}$ Au ions at a uence of $1 \, 10^{14}$ ions cm 2 at 0, 30 and 60 -impact angle, respectively. For this thickness there is no embedding for 0 -impact and fullembedding for 60 -impact. Some embedding can be seen for 30 -impact angle as well. From these results, we may infer that embedding ismore for higher impact angles. However, we have not checked whether it is more or not if impact angle is higher than 60. From the contrast near the silicon surface seen in Fig. 4 (a), 4 (b), 5 (c) and 5 (d) it appears that some Au has been pushed into silicon. In order to demonstrate that the contrast is indeed due to incorporation of Au into silicon, we have done aqua-regia treatment and carried out RBS measurements, which proves beyond doubt that indeed Au has entered into silicon [24].

To understand more about the mixing and phase formation, we have done high resolution lattice imaging from the mixed region (data not shown). The lattice image shows a dapacing of 0.224 0.01 nm for pristine Au/Si (with native oxide) system, which is closer to (111) interplanar spacing of pristine and bulk Au ions. Upon irradiation with 32 keV and $1.5 \, \mathrm{MeV}$ Au ions at a under of 1.0^{14} ions cm 2 and at an impact angle of 0.30 and 60, the

lattice spacing is found to be 0.293-0.01~nm. This value does not match with any of the interplanar spacing available for the pure gold. Thus, we conclude that this must belong to a metastable phase of Au/Sisystem. The mixed phase reported here is crystalline in nature [24].

From Figs. 4(b) and 5(b) it is evident that embedding of Au into Si at 0 largely depends on Au Im thickness. From our earlier measurement [24] we have seen that for 0 as well as for 60 -im pact there is no embedding in case of sem i-continuous (94% Im coverage) and in thick continuous Au Im on Si for irradiation at a uence of $1 ext{ } 10^{14}$ ions cm 2 . In all the cases whenever there is a embedding (Fig. 4(a), 4(b), 5(c), 5(d)), embedded Au form a reacted material gold-silicide in the sub surface region.

4 Conclusions

We studied keV-MeV Au ion-irradiation elects on isolated nanoislands which were grown on Sisubstrates. We have collected sputtered particle on catcher grid. From TEM measurement sputtering is more in MeV energy region than keV region. RBS results con me the elect through enhanced reduction in thickness for the limit irradiated with 1.5 MeV and 100 MeV. Au ions in comparison with that of 32 keV irradiation. We have provided an experimental evidence for an ion beam induced material push-in (or burrowing) for 32 keV and 1.5 MeV. Au ion irradiation in nanoislands and nanosilicide formation in nano-Au/Si and its absence in case of 100 MeV irradiation. The formation of nanosilicide may be useful in fabricating embedded nanostructures such as nanocontacts and Schottky barriers. The embedding of nanoislands inside Si has been studied as a function of impact angle. Embedding is prominent at higher impact angles than at normal incidence.

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Figure Captions:

Figure 1: Plan-view TEM images: (a) as-deposited 2.6 nm thick Au lm on native oxide coated silicon substrate; (b), (c) and (d) correspond to sputtered particles collected from samples (a), which were irradiated with 32 keV, 1.5 M eV and $100 \, \text{M}$ eV Au ions, respectively with a uence of $1 \, 10^{14}$ ions cm 2 at normal incidence (0 -impact angle); (e) shows sputtered particles collected from the same region as in (d)) by some underfocousing of the objective lens; (f) shows high resolution image of a sputtered particle obtained after $100 \, \text{M}$ eV Au ion irradiation.

Figure 2: Size distribution of the sputtered particle collected on catcher grid following (a) 32 keV, (b) 1.5 M eV, and (c) 100 M eV Au ion irradiation with ion uence of $1 \cdot 10^{14}$ ions cm 2 at normal incidence.

Figure 3: RBS spectra obtained from as-deposited and ion-irradiated sam ples (at a uence of 1 10^{14} ions cm 2 at normal incidence) for (a) 32 keV, (b) $1.5~{\rm M}$ eV, and (c) $100~{\rm M}$ eV Au ion irradiation.

Figure 4: XTEM images of ion irradiated 2.6 nm Au/native-oxide/Siwith uence of 1 10^{14} ions cm 2 at normal incidence: (a) 32 keV Au ions, (b) $1.5\,\mathrm{M}$ eV Au $^{2+}$ ions and (c) $100\,\mathrm{M}$ eV Au $^{8+}$ ions.

Figure 5: XTEM images of 1.3 nm Au lm on native-oxide/Si substrate following $1.5\,\mathrm{M}$ eV Au $^{2+}$ bom bardment with ion uence of 1.0^{14} ions cm 2 : (a) as-deposited, (b) 0 -impact angle, (c) 30 -impact angle, (d) 60 -impact angle.

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